- Contains Six Flip-Flops With Single-Rail Outputs
- Buffered Clock and Direct Clear Inputs
- Applications Include: Buffer/Storage Registers Shift Registers

Pattern Generators

- Fully Buffered Outputs for Maximum Isolation From External Disturbances
- Package Options Include Plastic Small-Outline Packages and Standard Plastic 300-mil DIPs

(TOP VIEW) CLR 16 V_{CC} 1Q [2 15 **6**Q 3 1D Π 14**∏** 6D 4 13**∏** 5D 2D | 12 1 5Q 2Q 5 11 | 4D 3D 6 10 1 4Q 7 3Q 9 CLK **GND**

D OR N PACKAGE

description

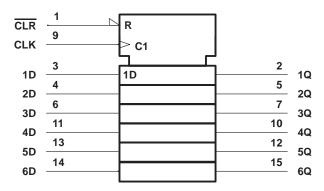
This monolithic, positive-edge-triggered flip-flop utilizes TTL circuitry to implement D-type flip-flop logic with a direct clear (CLR) input. Information at the data (D) inputs meeting the setup time requirements is transferred to the outputs on the positive-going edge of the clock pulse. Clock triggering occurs at a particular voltage level and is not directly related to the transition time of the positive-going pulse. When the clock (CLK) input is at either the high or low level, the D-input signal has no effect at the output.

The SN74F174A is characterized for operation from 0°C to 70°C.

FUNCTION TABLE (each flip-flop)

	INPUTS		OUTPUT
CLR	CLK	D	Q
Н	L	Х	Q ₀
Н	\uparrow	Н	Н
Н	\uparrow	L	L
L	Х	Χ	L

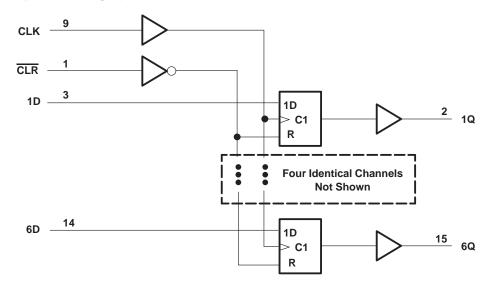
logic symbol†



[†] This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.



logic diagram (positive logic)



absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage range, V _{CC}	0.5 V to 7 V
Input voltage range, V _I (see Note 1)	1.2 V to 7 V
Input current range	30 mA to 5 mA
Voltage applied to any output in the high state	\dots -0.5 V to V _{CC}
Current into any output in the low state	40 mA
Operating free-air temperature range	0°C to 70°C
Storage temperature range	. −65°C to 150°C

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

recommended operating conditions

		MIN	NOM	MAX	UNIT
VCC	Supply voltage	4.5	5	5.5	V
VIH	High-level input voltage	2			V
VIL	Low-level input voltage			0.8	V
lik	Input clamp current			-18	mA
IOH	High-level output current			-1	mA
I _{OL}	Low-level output current			20	mA
TA	Operating free-air temperature	0		70	°C



NOTE 1: The input-voltage ratings may be exceeded provided the input-current ratings are observed.

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CON	TEST CONDITIONS				UNIT
VIK	$V_{CC} = 4.5 \text{ V},$	I _I = – 18 mA			- 1.2	V
Vou	$V_{CC} = 4.5 \text{ V},$	$I_{OH} = -1 \text{ mA}$	2.5	3.4		V
Voн	$V_{CC} = 4.75 V,$	$I_{OH} = -1 \text{ mA}$	2.7			V
V _{OL}	$V_{CC} = 4.5 V,$	$I_{OL} = 20 \text{ mA}$		0.3	0.5	V
ΙĮ	$V_{CC} = 5.5 V,$	V _I = 7 V			0.1	mA
lін	$V_{CC} = 5.5 V,$	V _I = 2.7 V			20	μΑ
I _{IL}	$V_{CC} = 5.5 V,$	V _I = 0.5 V			- 0.6	mA
los [‡]	$V_{CC} = 5.5 V,$	VO = 0	- 60		- 150	mA
Іссн	V _{CC} = 5.5 V,	See Note 2		30	45	mA
ICCL	V _{CC} = 5.5 V,	See Note 3		39	55	mA

[†] All typical values are at $V_{CC} = 5 \text{ V}$, $T_A = 25^{\circ}\text{C}$.

timing requirements

			V _{CC} =	= 5 V, 25°C	V _{CC} = 4.5 T _A = MIN t	UNIT		
			MIN	MAX	MIN	MAX		
fclock	Clock frequency		0	100	0	80	MHz	
		CLK high	4		4			
t _W	Pulse duration	CLK low	6		6		ns	
		CLR low	5		5			
	Output form hafare OLKA	Data high or low	4.5		4.5			
t _{su}	Setup time before CLK↑	CLR high¶	5		5		ns	
th	Hold time after CLK↑	Data high or low	0.5		1		ns	

[§] For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

switching characteristics (see Note 4)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	C _L R _L	C = 5 V, = 50 pF = 500 Ω = 25°C	,	V _{CC} = 4.5 C _L = 50 pl R _L = 500 Q T _A = MIN	UNIT	
			MIN	TYP	MAX	MIN	MAX	
f _{max}			100	140		80		MHz
^t PLH	CLK	Any Q	2.7	4.5	8	2.7	9	ns
t _{PHL}	OLK	Ally Q	3.4	4.2	10	3.3	11	115
^t PHL	CLR	Any Q	4.2	6.3	14	4.2	15	ns

NOTE 4: Load circuits and waveforms are shown in Section 1.



[‡] Not more than one output should be shorted at a time, and the duration of the short circuit should not exceed one second.

NOTES: 2. I_{CCH} is measured with all outputs open, all data inputs and enable input at 4.5 V, and the clock input at 4.5 V after being momentarily grounded.

^{3.} ICCL is measured with all outputs open, all data inputs and enable input at 0 V, and the clock input at 4.5 V after being momentarily grounded.

 $[\]P$ Inactive-state setup time is also referred to as recovery time.

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PACKAGING INFORMATION

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan	Lead finish/ Ball material	MSL Peak Temp	Op Temp (°C)	Device Marking (4/5)	Samples
SN74F174AD	OBSOLETE	SOIC	D	16		TBD	Call TI	Call TI	0 to 70	F174A	
SN74F174ADR	ACTIVE	SOIC	D	16	2500	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	F174A	Samples
SN74F174ADRE4	ACTIVE	SOIC	D	16	2500	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	F174A	Samples
SN74F174AN	ACTIVE	PDIP	N	16	25	RoHS & Green	NIPDAU	N / A for Pkg Type	0 to 70	SN74F174AN	Samples

(1) The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

RoHS Exempt: Til defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (CI) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

- (3) MSL, Peak Temp. The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.
- (4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.
- (5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.
- (6) Lead finish/Ball material Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

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PACKAGE OPTION ADDENDUM

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PACKAGE MATERIALS INFORMATION

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TAPE AND REEL INFORMATION





A0	Dimension designed to accommodate the component width
В0	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



*All dimensions are nominal

Device		Package Drawing		SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
SN74F174ADR	SOIC	D	16	2500	330.0	16.4	6.5	10.3	2.1	8.0	16.0	Q1

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*All dimensions are nominal

	Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)	
ı	SN74F174ADR	SOIC	D	16	2500	353.0	353.0	32.0	

PACKAGE MATERIALS INFORMATION

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TUBE



*All dimensions are nominal

Device	Package Name	Package Type	Pins	SPQ	L (mm)	W (mm)	T (µm)	B (mm)
SN74F174AN	N	PDIP	16	25	506	13.97	11230	4.32
SN74F174AN	N	PDIP	16	25	506	13.97	11230	4.32

D (R-PDS0-G16)

PLASTIC SMALL OUTLINE



NOTES:

- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.006 (0,15) each side.
- Body width does not include interlead flash. Interlead flash shall not exceed 0.017 (0,43) each side.
- E. Reference JEDEC MS-012 variation AC.



N (R-PDIP-T**)

PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN



NOTES:

- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
- The 20 pin end lead shoulder width is a vendor option, either half or full width.



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